

RoHS

COMPLIANT

HALOGEN

Available

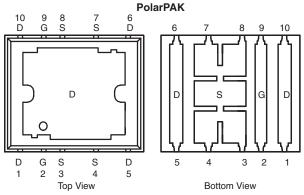
Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
		I _D (A) ^a			
V _{DS} (V)	R _{DS(on)} (Ω) ^e	Silicon Limit	Package Limit	Q _g (Typ.)	
30	0.0016 at V _{GS} = 10 V	211	60	43 nC	
50	0.0022 at V_{GS} = 4.5 V	180	60	43110	

Package Drawing

www.vishay.com/doc?72945



Top surface is connected to pins 1, 5, 6, and 10

Ordering Information: SiE848DF-T1-E3 (Lead (Pb)-free)

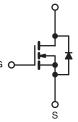
SiE848DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Gen III Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{ad}/Q_{as} Ratio Helps Prevent Shoot-Through
- 100 % R_g and UIS Tested
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- VRM
- DC/DC Conversion: Low-Side
- Synchronous Rectification



D

N-Channel MOSFET For Related Documents www.vishay.com/ppg?68821

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		211 (Silicon Limit)		
	10 - 25 0		60 ^a (Package Limit)		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	60 ^a		
	T _A = 25 °C		43 ^{b, c}		
	T _A = 70 °C		34 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	100		
Continuous Source-Drain Diode Current	T _C = 25 °C		60 ^a		
Continuous Source-Diain Diode Current	T _A = 25 °C	Is	4.3 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	50		
Avalanche Energy	L = 0.1 mm	E _{AS}	125	mJ	
	T _C = 25 °C		125		
Maximum Power Dissipation	T _C = 70 °C	P _D	80	w	
Maximum Power Dissipation	T _A = 25 °C	'D	5.2 ^{b, c}	• • •	
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		
Soldering Recommendations (Peak Temper	ature) ^{d, e}		260	U	

Notes:

a. Package limited is 60 A.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile (<u>www.vishay.com/doc?73257</u>). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	20	24	
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	0.8	1	°C/W
Maximum Junction-to-Case (Source) ^{a, c}	Sleady State	R _{thJC} (Source)	2.2	2.7	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Maximum under Steady State conditions is 68 °C/W.

c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•		•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I _D = 250 μA		30		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \ \mu A$		- 6.0			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.0	1.8	2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Gata Voltaga Drain Current	I _{DSS} -	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
Drain-Source On-State Resistance ^a	Baar	V _{GS} = 10 V, I _D = 25 A		0.0013	0.0016	Ω	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		0.0018	0.0022		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 25 A		115		S	
Dynamic ^b							
Input Capacitance	C _{iss}			6100		pF	
Output Capacitance	C _{oss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz		1100			
Reverse Transfer Capacitance	C _{rss}			370			
Total Gate Charge	Qg	V_{DS} = 15 V, V_{GS} = 10 V, I_{D} = 20 A		92 138			
				43	65	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15$ V, $V_{GS} = 4.5$ V, $I_{D} = 20$ A		17			
Gate-Drain Charge	Q _{gd}			11			
Gate Resistance	R _g	f = 1 MHz		1.1	2.2	Ω	
Turn-On Delay Time	t _{d(on)}			45	70		
Rise Time	t _r	$\label{eq:VDD} \begin{array}{l} V_{DD} = 15 \; V, \; R_L = 1.5 \; \Omega \\ I_D \cong 10 \; A, \; V_GEN = 4.5 \; V, \; R_g = 1 \; \Omega \end{array}$		30	45		
Turn-Off Delay Time	t _{d(off)}			70	105		
Fall Time	t _f			40	60		
Turn-On Delay Time	t _{d(on)}			20	30	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		10	15		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω		50	75		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ _S	$T_{C} = 25 \ ^{\circ}C$			60	A	
Pulse Diode Forward Currenta	I _{SM}				100	~	
Body Diode Voltage	V _{SD}	I _S = 10 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			40	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		50	75	nC	
Reverse Recovery Fall Time	t _a	$r_{\rm F} = 10$ Å, di/dl = 100 Å/µ3, $r_{\rm J} = 25$ °C		21		nc	
Reverse Recovery Rise Time	t _b			19		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

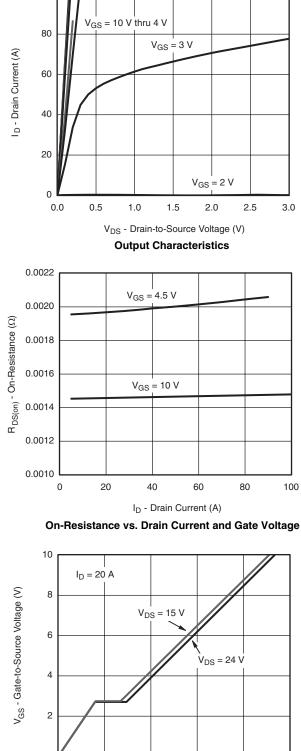


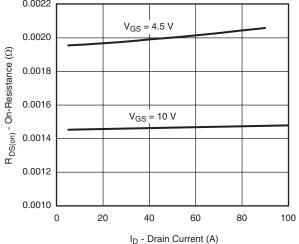
100

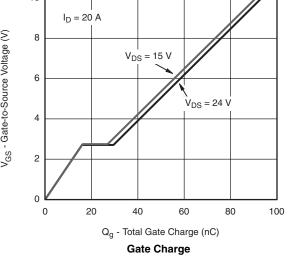
SiE848DF

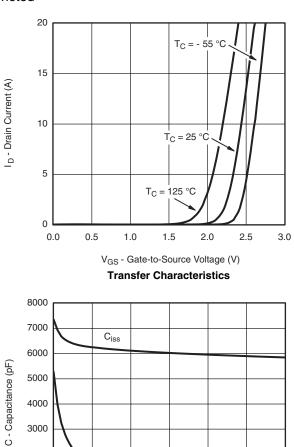
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









4000

3000

2000

1000

0

0

C_{rss}

5

Coss

10

15

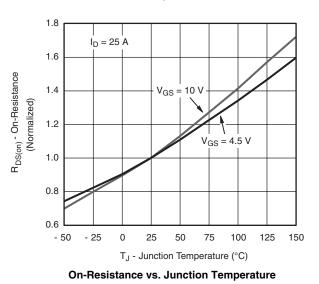
V_{DS} - Drain-to-Source Voltage (V)

Capacitance

20

25

30

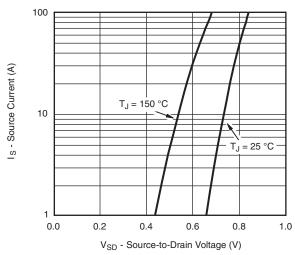


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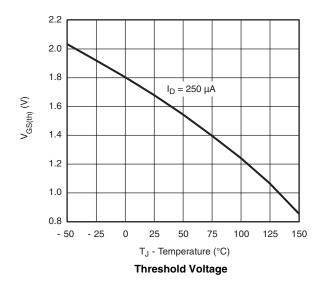
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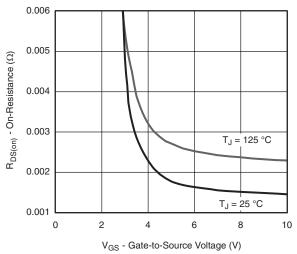


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

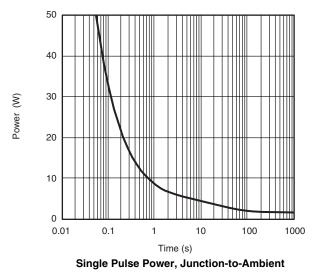


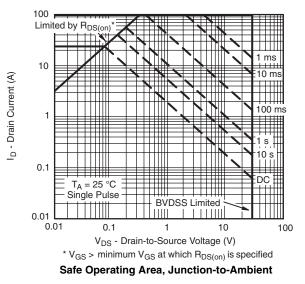






On-Resistance vs. Gate-to-Source Voltage



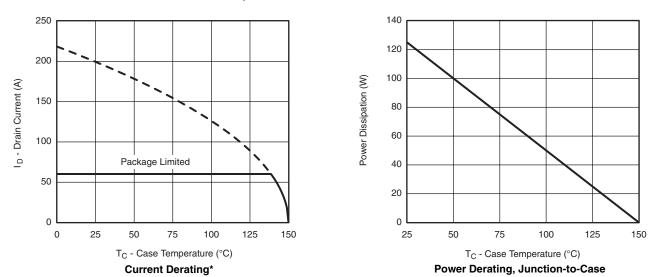


New Product



SiE848DF

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

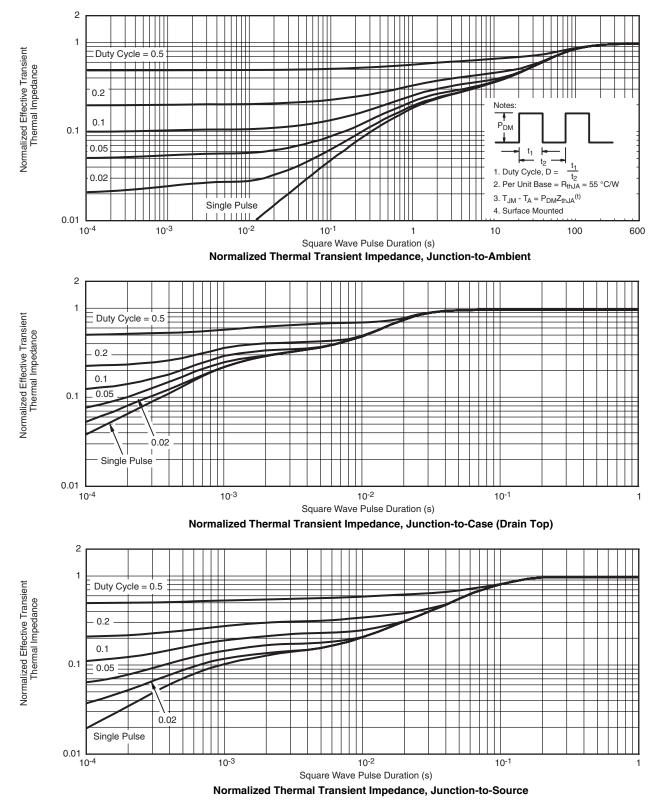
* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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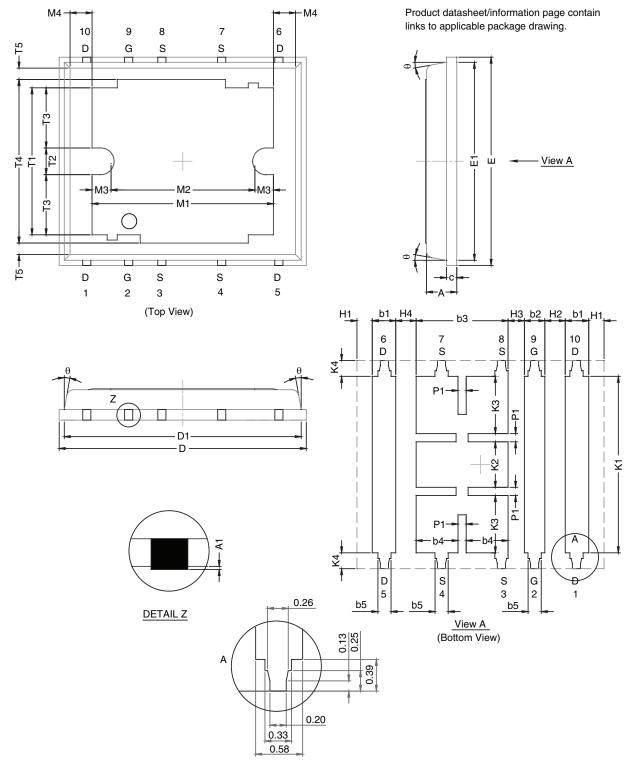
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?68821</u>.



Package Information

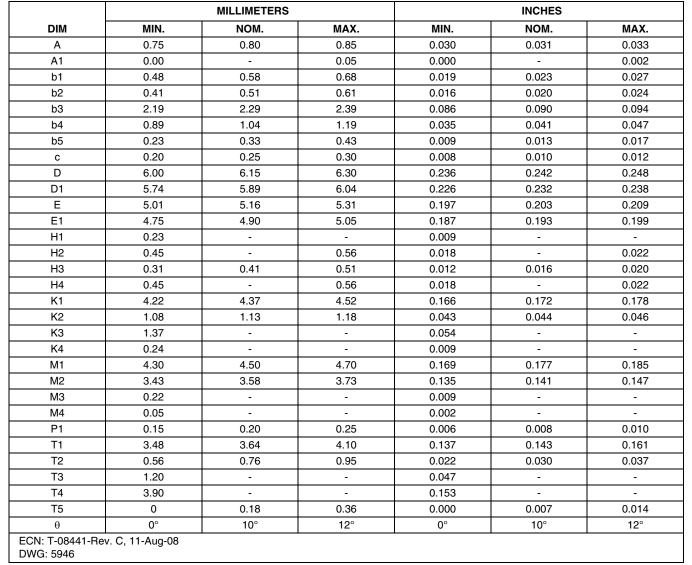
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POLARPAK™ OPTION L



Package Information

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Notes

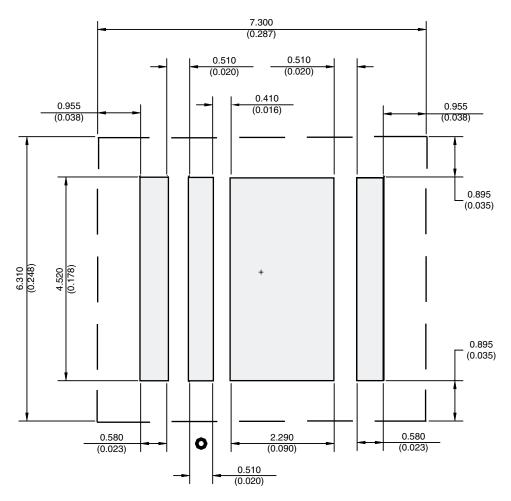
Millimeters govern over inches.



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RECOMMENDED MINIMUM PADS FOR PolarPAK® Option L and S



Recommended Minimum for PolarPAK Option L and S Dimensions in mm/(Inches) No External Traces within Broken Lines Dot indicates Gate Pin (Part Marking)

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